

# 4V Drive Nch MOSFET

## RSD200N10

### ●Structure

Silicon N-channel MOSFET

### ●Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Wide SOA (safe operating area).
- 4) Gate-source voltage ( $V_{GS}$ ) guaranteed to be  $\pm 20V$ .
- 5) Drive circuits can be simple.
- 6) Parallel use is easy.

### ●Applications

Switching

### ●Packaging specifications

	Package	Taping
	Code	TL
Type	Basic ordering unit (pieces)	2500
RSD200N10		○

### ●Absolute maximum ratings (Ta=25°C)

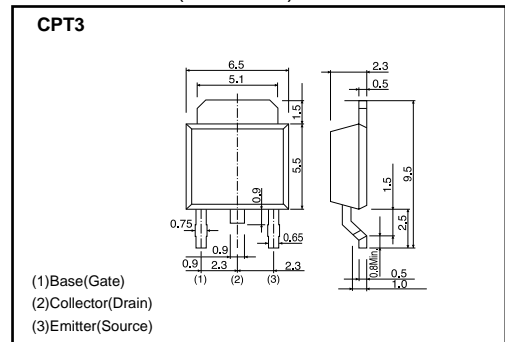
Parameter	Symbol	Limits	Unit	
Drain-source voltage	$V_{DSS}$	100	V	
Gate-source voltage	$V_{GS}$	$\pm 20$	V	
Drain current	Continuous	$I_D$ *3	$\pm 20$	A
	Pulsed	$I_{DP}$ *1	$\pm 80$	A
Source current (Body Diode)	Continuous	$I_S$	20	A
	Pulsed	$I_{SP}$ *1	80	A
Avalanche Current	$I_{AS}$ *2	20	A	
Avalanche Energy	$E_{AS}$ *2	85	mJ	
Total power dissipation (Tc=25°C)	$P_D$	20	W	
Channel temperature	$T_{ch}$	150	°C	
Range of storage temperature	$T_{stg}$	-55 to +150	°C	

\*1  $P_w \leq 10\mu s$ , Duty cycle  $\leq 1\%$   
 \*2  $L = 265\mu H$ ,  $V_{ob} = 50V$ ,  $R_G = 25\Omega$ , Starting,  $T_{ch} = 25^\circ C$   
 \*3 Limited only by maximum temperature allowed

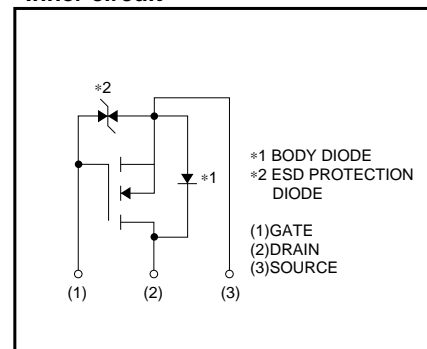
### ●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to case	$R_{th(ch-c)}$	6.25	°C/W

### ●Dimensions (Unit : mm)



### ●Inner circuit



## ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I <sub>GSS</sub>	–	–	±10	μA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	100	–	–	V	I <sub>D</sub> =1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	I <sub>DSS</sub>	–	–	10	μA	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS(th)</sub>	1.0	–	2.5	V	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA
Static drain-source on-state resistance	R <sub>DS(on)</sub> *	–	41	52	mΩ	I <sub>D</sub> =10A, V <sub>GS</sub> =10V
		–	44	58	mΩ	I <sub>D</sub> =10A, V <sub>GS</sub> =4.5V
		–	45	59	mΩ	I <sub>D</sub> =10A, V <sub>GS</sub> =4.0V
Forward transfer admittance	Y <sub>fs</sub>   *	14	–	–	S	I <sub>D</sub> =10A, V <sub>DS</sub> =10V
Input capacitance	C <sub>iss</sub>	–	2200	–	pF	V <sub>DS</sub> =25V
Output capacitance	C <sub>oss</sub>	–	180	–	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	C <sub>rss</sub>	–	110	–	pF	f=1MHz
Turn-on delay time	t <sub>d(on)</sub> *	–	18	–	ns	I <sub>D</sub> =10A, V <sub>DD</sub> =50V
Rise time	t <sub>r</sub> *	–	61	–	ns	V <sub>GS</sub> =10V
Turn-off delay time	t <sub>d(off)</sub> *	–	128	–	ns	R <sub>L</sub> =5Ω
Fall time	t <sub>f</sub> *	–	193	–	ns	R <sub>G</sub> =10Ω
Total gate charge	Q <sub>g</sub> *	–	48.5	–	nC	V <sub>DD</sub> =50V
Gate-source charge	Q <sub>gs</sub> *	–	5.5	–	nC	I <sub>D</sub> =20A V <sub>GS</sub> =10V
Gate-drain charge	Q <sub>gd</sub> *	–	13	–	nC	R <sub>L</sub> =2.5Ω / R <sub>G</sub> =10Ω

\* Pulsed

## ●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V <sub>SD</sub> *	–	–	1.5	V	I <sub>S</sub> =20A, V <sub>GS</sub> =0V

\* Pulsed

●Electrical characteristic curves

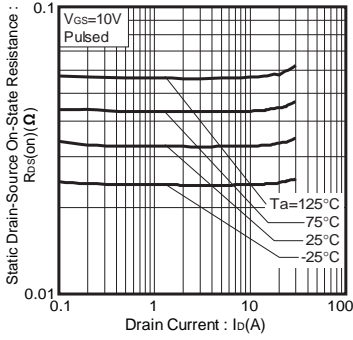


Fig.1 Static Drain-Source On-State Resistance vs. Drain Current

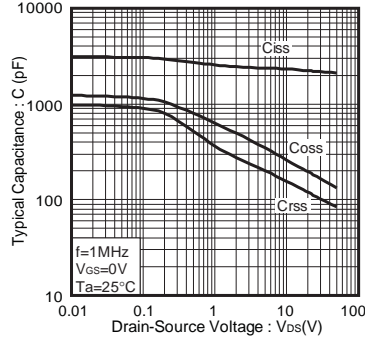


Fig.2 Typical Capacitance vs. Drain-Source Voltage

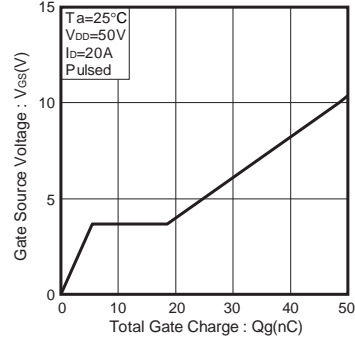


Fig.3 Dynamic Input Characteristics

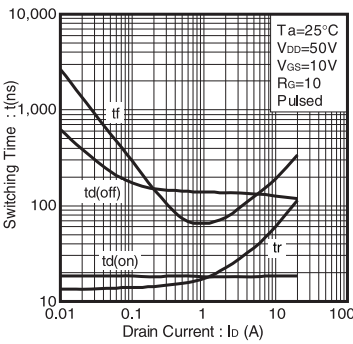


Fig.4 Switching Characteristics

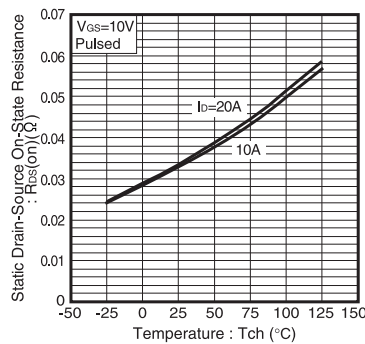


Fig.5 Static Drain-Source On-State Resistance vs. Channel Temperature

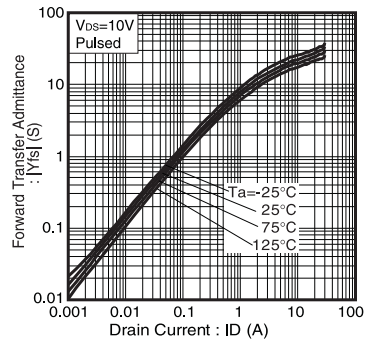


Fig.6 Forward Transfer Admittance vs. Pulsed

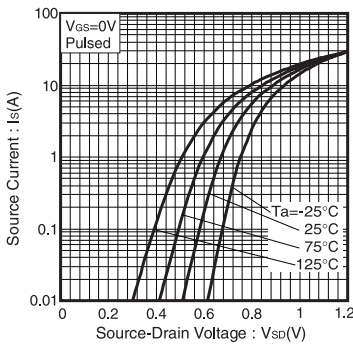


Fig.7 Source Current vs. Source-Drain Voltage

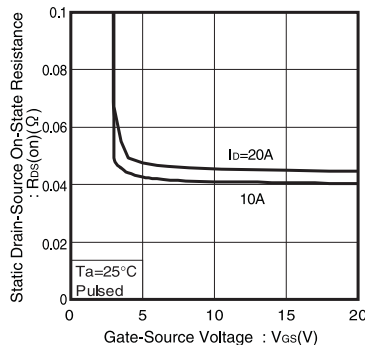


Fig.8 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

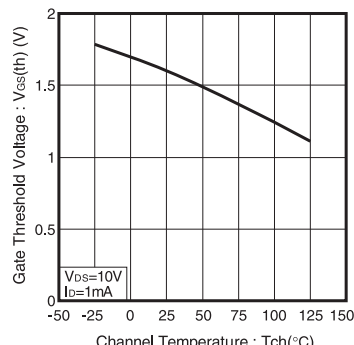


Fig.9 Gate Threshold Voltage vs. Channel Temperature

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